



Tape No: 3-992AMB-FILM

Polyimide 2-mil Film – No Adhesive

Features:

- Polyimide film designed for high temperature masking applications
- Protects printed circuit board gold finger contacts during wave soldering
- Used in electrical insulation applications meeting class H requirements
- Thin and conformable enabling masking of uneven surfaces
- Wide operating temperature range up to 500°F
- Excellent electrical insulation
- Removes cleanly without adhesive residue after exposure to heat/chemical

Technical Data:

Film Thickness: (mils)	2
Adhesive Thickness: (mils)	0
Total Thickness: (mils)	2
Adhesion to Steel: (Oz/inch)	25
Tensile Strength: (Lbs/inch)	50
Dielectric Strength: (Volts)	11,000
Color:	Amber
Adhesion Type:	None
Temperature Resistance:	260°C (500°F)
Insulation Class: (centigrade)	180°
Elongation: (%)	>55

Size:

Tape Length (Yds):	36
Tape Width (in):	cut to size

Applications:

1. Mask for protection of gold fingers of printed circuit boards during wave solder or solder dip process.
2. Release surface in fabrication of parts cured at elevated temperatures.
3. Widely used for electrical insulation on transformer, motor, coils, PCB making, etc.

Remark

All information and recommendations are given by us in good faith, on the basis of practical experience, but without warranty. It's essential that the user should evaluate the product for a period of time to determine whether it is fit for a particular purpose and suitable for the user's method of application.